

SLOVENSKI STANDARD SIST EN IEC 62435-8:2020

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Elektronske komponente - Dolgoročno skladiščenje elektronskih polprevodniških elementov - 8. del: Pasivne elektronske naprave (IEC 62435-8:2020)

Electronic components - Long-term storage of electronic semiconductor devices - Part 8: Passive elecronic devices (IEC 62435-8:2020)

Elektronische Bauteile - Langzeitlagerung elektronischer Halbleiterbauelemente - Teil 8: Passive elektronische Bauelemente (IEC 62435-8:2020)

Composants électroniques - Stockage de longue durée des dispositifs électroniques à semiconducteurs - Partie 8 : Dispositifs électroniques passifs (IEC 62435-8:2020)

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ICS:

31.080.01 Polprevodniški elementi (naprave) na splošno Semiconductor devices in general

SIST EN IEC 62435-8:2020

en

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Electronic components - Long-term storage of electronic semiconductor devices - Part 8: Passive electronic devices (IEC 62435-8:2020)

Composants électroniques - Stockage de longue durée des dispositifs électroniques à semiconducteurs - Partie 8 : Dispositifs électroniques passifs (IEC 62435-8:2020) Elektronische Bauteile - Langzeitlagerung elektronischer Halbleiterbauelemente - Teil 8: Passive elektronische Bauelemente (IEC 62435-8:2020)

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European foreword

The text of document 47/2595/CDV, future edition 1 of IEC 62435-8, prepared by IEC/TC 47 "Semiconductor devices" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN IEC 62435-8:2020.

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¹ Under preparation. Stage at the time of publication: IEC AFDIS 62435-7:2020.

² Under preparation. Stage at the time of publication: prEN IEC 62435-7:2019.

Annex ZA (normative)

Normative references to international publications with their corresponding European publications

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE 1 Where an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: www.cenelec.eu.

Publication	<u>Year</u>	Title	EN/HD	<u>Year</u>
IEC 60749-20		Semiconductor devices - Mechanical and climatic test methods - Part 20: Resistance of plastic encapsulated SMDs to the combined effect of moisture and soldering heat F V F V	EN 60749-20	-
IEC 60749-20-1		Semiconducton devices - Mechanical and climatic test methods - Part 20-1: Handling, packing, labelling and shipping of surface- mount devices sensitive to the combined effect of moisture and soldering heat ^{2-41a8-4753-} 0dfab64b194b/sist-en-icc-62435-8-2020	- a57b-	-
IEC 61760-4		Surface mounting technology - Part 4: Classification, packaging, labelling and handling of moisture sensitive devices	EN 61760-4	-
JEDEC J-STD-075		Classification of non-IC electronic components for assembly processes	-	-

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INTERNATIONAL STANDARD

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Electronic compo**hents**–Song-term storage billectronic semiconductor devices – (standards.iteh.ai) Part 8: Passive electronic devices

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Composants électroniques **Exact Stockage des longues durée des dispositifs** électroniques à semiconductéurs⁴ L/sist-en-iec-62435-8-2020 Partie 8: Dispositifs électroniques passifs

INTERNATIONAL ELECTROTECHNICAL COMMISSION

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

ELECTRONIC COMPONENTS – LONG-TERM STORAGE OF ELECTRONIC SEMICONDUCTOR DEVICES –

Part 8: Passive electronic devices

FOREWORD

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International Standard IEC 62435-8 has been prepared by subcommittee IEC technical committee 47: Semiconductor devices.

The text of this International Standard is based on the following documents:

CDV	Report on voting
47/2595/CDV	47/2618/RVC

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

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A list of all the parts in the IEC 62435 series, published under the general title *Electronic components – Long-term storage of electronic semiconductor devices*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "http://webstore.iec.ch" in the data related to the specific document. At this date, the document will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

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INTRODUCTION

This document applies to the long-term storage of passive electronic components.

This is a standard for long-term storage (LTS) of electronic devices drawing on the best longterm storage practices currently known. For the purposes of this document, LTS is defined as any device storage whose duration can be more than 12 months for product scheduled for long duration storage. While intended to address the storage of unpackaged semiconductors and packaged electronic devices, nothing in this document precludes the storage of other items under the storage levels defined herein.

Although it has always existed to some extent, obsolescence of electronic components and particularly of integrated circuits, has become increasingly intense over the last few years.

Indeed, with the existing technological boom, the commercial life of a component has become very short compared with the life of industrial equipment such as that encountered in the aeronautical field, the railway industry or the energy sector.

The many solutions enabling obsolescence to be resolved are now identified. However, selecting one of these solutions should be preceded by a case-by-case technical and economic feasibility study, depending on whether storage is envisaged for field service or production, for example:

- remedial storage as soon as components are no longer marketed;
- preventive storage anticipating declaration of obsolescence.

Taking into account the expected life of some installations, sometimes covering several decades, the qualification times, and the unavailability costs, which can also be very high, the solution to be adopted to resolve obsolescence should often be rapidly implemented. This is why the solution retained in most cases consists in systematically storing components which are in the process of becoming obsolescent.

The technical risks of this solution are, a priori, fairly low. However, it requires perfect mastery of the implemented process and especially of the storage environment, although this mastery becomes critical when it comes to long-term storage.

All handling, protection, storage and test operations are recommended to be performed according to the state of the art.

The application of the approach proposed in this document in no way guarantees that the stored components are in perfect operating condition at the end of this storage. It only comprises a means of minimizing potential and probable degradation factors.

Some electronic device users have the need to store electronic devices for long periods of time. Lifetime buys are commonly made to support production runs of assemblies that well exceed the production timeframe of its individual parts. This puts the user in a situation requiring careful and adequate storage of such parts to maintain the as-received solderability and minimize any degradation effects to the part over time. Major degradation concerns are moisture, electrostatic fields, ultraviolet light, large variations in temperature, air-borne contaminants, and outgassing.

Warranties and sparing also present a challenge for the user or repair agency as some systems have been designated to be used for long periods of time, in some cases for up to 40 years or more. Some of the devices needed for repair of these systems will not be available from the original supplier for the lifetime of the system or the spare assembly may be built with the original production run but then require long-term storage. This document was developed to provide a standard for storing electronic devices for long periods of time. For storage